

PATENT ASSIGNMENT

Electronic Version v1.1
Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Seung Hee JO</td><td>04/05/2011</td></tr><tr><td>Seong Cheol KIM</td><td>04/05/2011</td></tr></tbody></table>		Name	Execution Date	Seung Hee JO	04/05/2011	Seong Cheol KIM	04/05/2011		
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Seong Cheol KIM	04/05/2011								
RECEIVING PARTY DATA									
<table border="1"><tr><td>Name:</td><td>Hynix Semiconductor Inc.</td></tr><tr><td>Street Address:</td><td>San 136-1, Ami-ri, Bubal-eup</td></tr><tr><td>City:</td><td>Icheon-si Gyeonggi-do</td></tr><tr><td>State/Country:</td><td>REPUBLIC OF KOREA</td></tr></table>		Name:	Hynix Semiconductor Inc.	Street Address:	San 136-1, Ami-ri, Bubal-eup	City:	Icheon-si Gyeonggi-do	State/Country:	REPUBLIC OF KOREA
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PROPERTY NUMBERS Total: 1									
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>13096338</td></tr></tbody></table>		Property Type	Number	Application Number:	13096338				
Property Type	Number								
Application Number:	13096338								
CORRESPONDENCE DATA									
Fax Number: (630)908-7653 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
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Total Attachments: 2 source=PA0229-0_Assignment#page1.tif source=PA0229-0_Assignment#page2.tif									

OP \$40.00 13096338

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PATENT
REEL: 026194 FRAME: 0354

DOCKET:

PATENT

ASSIGNMENT OF APPLICATION

Now, therefore, in consideration of the sum of one dollar (\$1), the receipt whereof is acknowledge, and other good and valuable consideration, I/We, the assignor(s)

ASSIGNOR(S)

JO, Seung Hee

#416-403, Jugong 4-danji Apt., Hansolmaeul, Jeongja-dong, Bundang-gu,
Seongnam-si, Gyeonggi-do, Republic of Korea

KIM, Seong Cheol

#101-402, Iljuk IC Town, Iljuk-myeon, Anseong-si, Gyeonggi-do, Republic of
Korea

by these presents do sell, assign and transfer unto said assignee

ASSINGEE

Hynix Semiconductor Inc.

San 136-1, Ami-ri, Bubal-eup, Icheon-si, Gyeonggi-do, Republic of Korea

and the heirs, successors, assigns and legal representatives of the assignee the full and exclusive right to the said invention in the United States which are disclosed in the U.S. patent application titled

**SEMICONDUCTOR CHIP AND SEMICONDUCTOR PACKAGE WITH STACK
CHIP STRUCTURE**

☐ for which an application for a United States Patent was filed on _____
Application Number _____; or

☐ for which an application for a United States Patent was executed by the undersigned on _____

and any and all improvements thereof, the entire rights, title and interest in and to any and all Patents which may be granted therefore in the United States. I/We hereby authorize and request the Director of the U.S. Patent and Trademark Office to issue said United States Patent to said assignee, of the entire right, title, and interest in and to the same, for his sole use and for the use of his legal representatives, to the full end of the term for which said Patent may be granted, as fully and entirely as the same would have been held by me had this assignment and sale not been made.

DOCKET:

PATENT

The assignor(s) agree promptly upon request of the Assignee, its heirs, successors, assigns and legal representatives of the assignee to communicate any facts known to it respecting the patent and the invention set forth therein, and to execute and deliver without further compensation any power of attorney, Assignment, application, whether original, continuation, divisional or reissue, or other papers that may be necessary or fully

Assignor(s) hereby covenants that no assignment, sale agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

Assignor(s) further covenants that assignee will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to Assignor(s) and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to assignee or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

ASSIGNOR SIGNATURE(S)

JO. Seung Hee
JO, Seung Hee

April 5, 2011
Date

KIM. Seong Cheol
KIM, Seong Cheol

April 5, 2011
Date